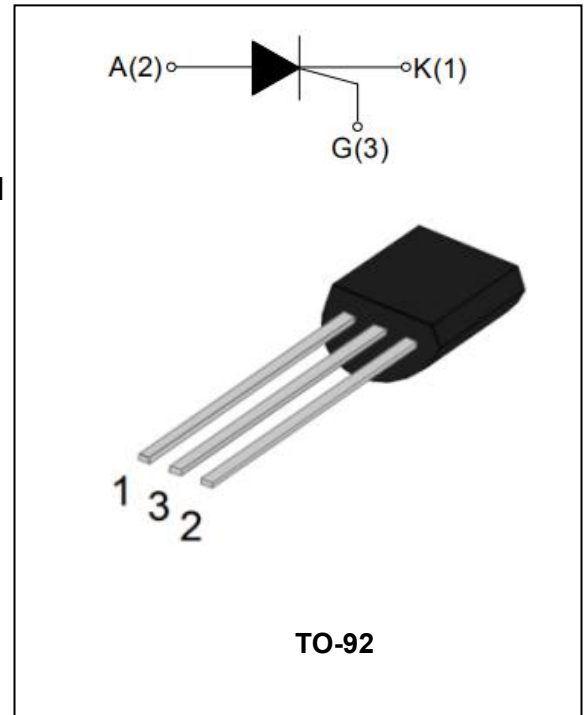


DESCRIPTION:

The MCR100-8 SCR series provide high dv/dt rate with strong resistance to electromagnetic interference. They are especially recommended for use on residual current circuit breaker, straight hair, igniter etc.

MAIN FEATURES:

symbol	value	unit
$I_{T(RMS)}$	1	A
V_{DRM}/V_{RRM}	800	V
V_{TM}	≤ 1.5	V



ABSOLUTE MAXIMUM RATINGS:

Parameter	Symbol	Value	Unit
Storage junction temperature range	T_{stg}	-40~150	$^{\circ}C$
Operating junction temperature range	T_j	-40~110	$^{\circ}C$
Repetitive peak off-state voltage ($T_j=25^{\circ}C$)	V_{DRM}	800	V
Repetitive peak reverse voltage ($T_j=25^{\circ}C$)	V_{RRM}	800	V
RMS on-state current ($T_c=80^{\circ}C$)	$I_{T(RMS)}$	1	A
Non repetitive surge peak on-state current (full cycle, $F=50Hz$)	I_{TSM}	10	A
I^2t value for fusing ($t_p=10ms$)	I^2t	0.5	A^2s
Critical rate of rise of on-state current ($I_G=2 \times I_{GT}$)	di/dt	50	$A/\mu s$
Peak gate current	I_{GM}	0.2	A
Average gate power dissipation	$P_{G(AV)}$	0.1	W
Peak gate power	P_{GM}	0.5	W

ELECTRICAL CHARACTERISTICS ($T_j=25^\circ\text{C}$ unless otherwise specified)

Symbol	Test Condition	Value			Unit
		MIN	TYPE	MAX	
I_{GT}	$V_D=12\text{V}, R_L=33\Omega$	-	20	200	μA
V_{GT}		-	0.5	1.0	V
V_{GD}	$V_D=V_{DRM}, T_j=110^\circ\text{C}$ $R_L=3.3\text{k}\Omega$	0.2	-	-	V
I_H	$I_T=50\text{mA}$	-	-	2	mA
I_L	$I_G=1.2I_{GT}$	-	-	3	mA
dV/dt	$V_D=0.66\times V_{DRM}, T_j=110^\circ\text{C}$ G 极开路 $R_{GK}=1\text{k}\Omega$	20	-	-	V/ μs

STATIC CHARACTERISTICS

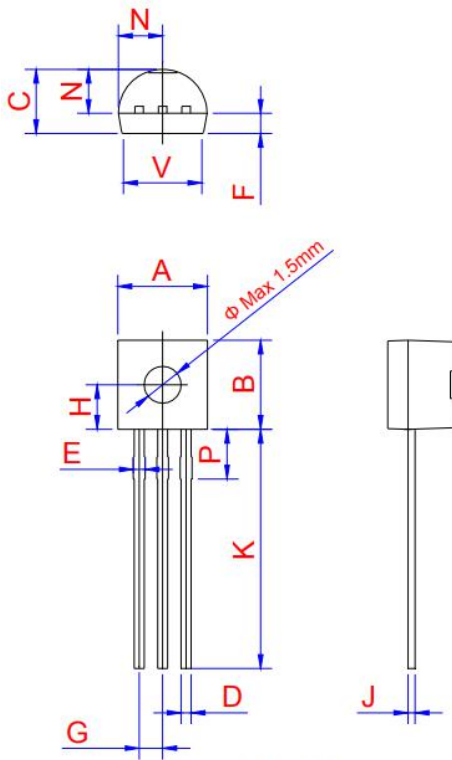
Symbol	Test Condition		Value	Unit
V_{TM}	$I_{TM}=2\text{A}$ $t_p=380\mu\text{s}$	$T_j=25^\circ\text{C}$	MAX	1.5 V
I_{DRM} I_{RRM}	$V_{DRM}=V_{RRM}$ $R_{GK}=1\text{k}\Omega$	$T_j=25^\circ\text{C}$	MAX	5 μA
		$T_j=110^\circ\text{C}$		100 μA

THERMAL RESISTANCES

Symbol	Test Condition		Value	Unit
$R_{th(j-c)}$	结到外壳(AC)		TO-92 50	$^\circ\text{C}/\text{W}$

ORDERING INFORMATION

M C R 1 0 0 - 8		
SCR	$I_{T(RMS)}: 1A$	$V_{DRM}, V_{RRM}: 800V$



TO-92

Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	4.45	4.6	5.2	0.175	0.181	0.205
B	4.32	4.6	5.33	0.17	0.181	0.21
C	3.18	3.55	4.19	0.125	0.14	0.165
D	0.407		0.533	0.016		0.021
E	0.6		0.8	0.024	0	0.031
F	-	1.1	-	-	0.043	-
G	-	1.27	-	-	0.05	-
H	-	2.3	-	-	0.091	-
J	0.36	0.38	0.5	0.014	0.015	0.02
K	12.7		15	0.5		0.591
N	2.04	2.3	2.66	0.08	0.091	0.105
P	1.86		2.06	0.073		0.081
V	-		4.3	-		0.169

FIG.1: Maximum power dissipation versus RMS on-state current

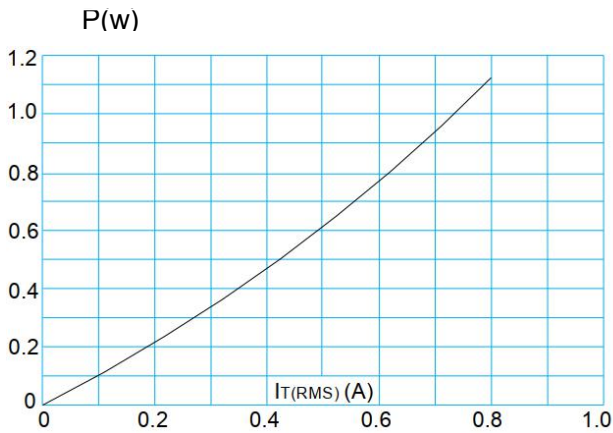


FIG.2: RMS on-state current versus case temperature

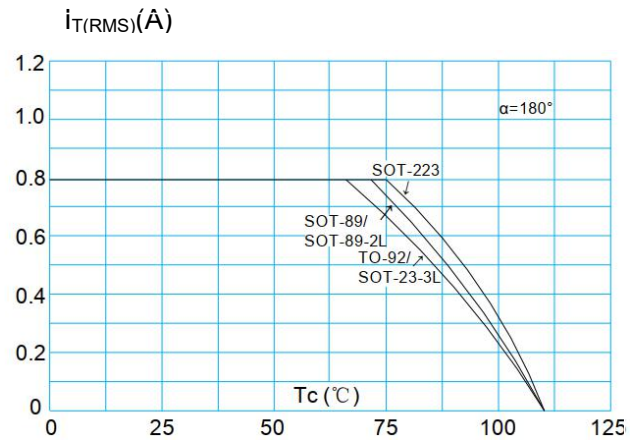


FIG.3: Surge peak on-state current versus number of cycles

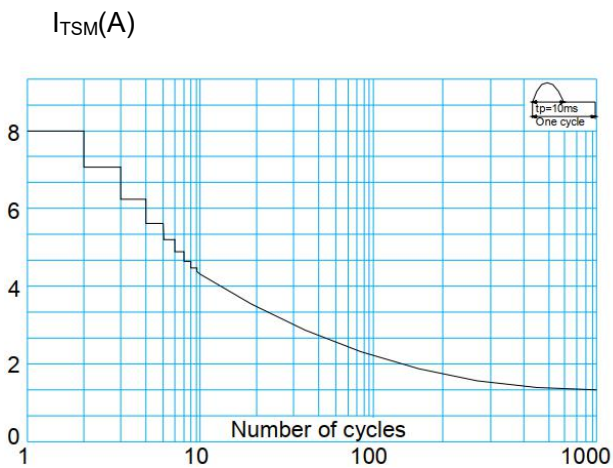


FIG.4: On-state characteristics (maximum values)

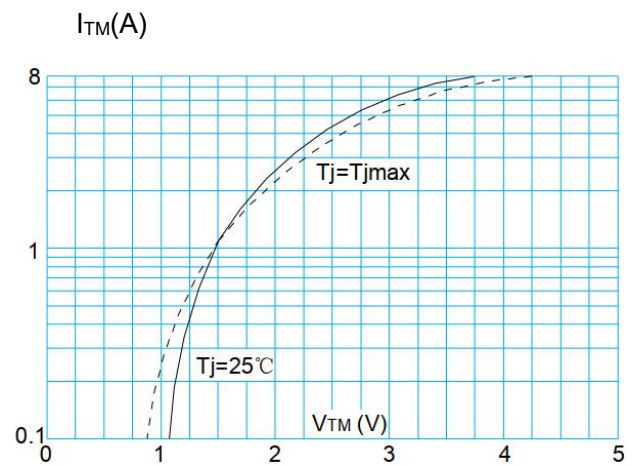


FIG.5: Non-repetitive surge peak on-state current for a sinusoidal pulse with width $t_p < 20ms$, and corresponding value of $I^2 t$ ($di/dt < 50A/\mu s$)

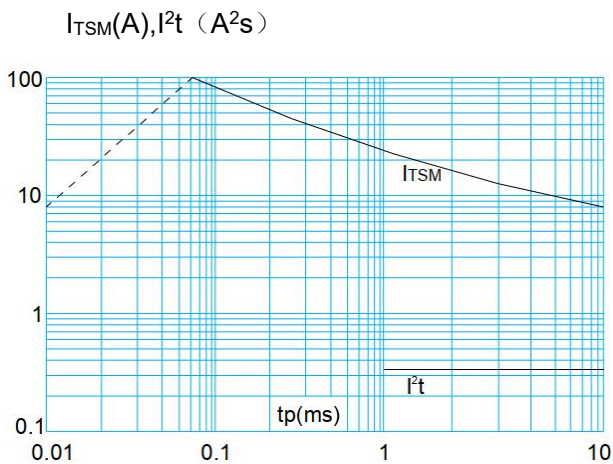


FIG.6: Relative variations of gate trigger current, holding current and latching current versus junction temperature

